

# SPIDER - TLE 7232G

SPI Driver for Enhanced Relay Control

Eight Channel Low-Side Switch

Automotive Power



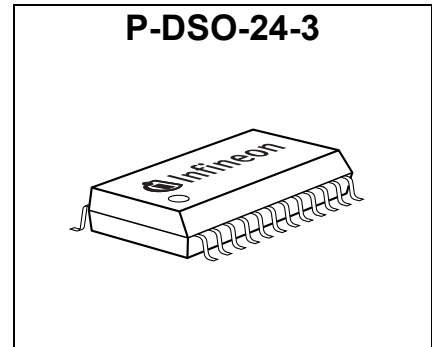
Never stop thinking

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The SPIDER - TLE 7232G is an eight channel low-side power switch in P-DSO-24-3 package providing embedded protective functions. It is especially designed for standard relays in automotive applications.

A serial peripheral interface (SPI) is utilized for control and diagnosis of the device and the load. For direct control, there is an input pin available.

The power transistors are built by N-channel vertical power MOSFETs. The device is monolithically integrated in Smart Power Technology.



## Product Summary

Supply voltage	$V_{dd}$	4.5 ... 5.5 V
Supply voltage for SO buffer	$V_{VSO}$	3.0 ... 5.5 V
On-State resistance at 25 °C	$R_{DS(ON, max)}$	1.2 $\Omega$
Nominal load current	$I_{L(nom, max)}$	240 mA
Over load current limitation	$I_{DS(LIM, min)}$	1 A
Output leakage current per channel at 25 °C	$I_{DS(OFF, max)}$	1 $\mu$ A
Drain to source clamping voltage	$V_{DS(CL, min)}$	48 V
SPI clock frequency	$f_{SCLK(max)}$	5 MHz

Type	Ordering Code	Package
SPIDER - TLE 7232G	SP0000-89034	P-DSO-24-3

## **Basic Features**

- 16 bit SPI for diagnostics and control
- SPI providing daisy chain capability
- 3.3 V and 5 V compatible SPI
- A configurable input pin offers complete flexibility for PWM operation
- Stable behavior at under voltage

## **Protective Functions**

- Short circuit protection
- Over load protection, configurable behavior (limitation or shutdown)
- Thermal shutdown, configurable behavior (latch or restart)
- Electrostatic discharge protection (ESD)

## **Diagnostic Functions**

- Diagnostic information via SPI
- Open load detection in OFF-state
- Shorted to GND detection in OFF-state
- Over temperature in ON-state
- Over load in ON-state

## **Applications**

- Especially designed for driving relays in automotive applications
- All types of capacitive, resistive and inductive loads

## 1 Overview

The SPIDER - TLE 7232G is an eight channel low-side relay switch (1.2  $\Omega$  per channel) in P-DSO-24-3 package providing embedded protective functions. The 16 bit serial peripheral interface (SPI) is utilized for control and diagnosis of the device and the loads. The SPI interface provides daisy-chain capability in order to assemble multiple devices in one SPI chain by using the same number of micro-controller pins.

The SPIDER - TLE 7232G is equipped with one input pin that can be individually routed to the output control of each channel thus offering complete flexibility in design and PCB-layout. The input mapping as well as the boolean operation between input signal and output control signal is configured via SPI.

The device provides full diagnosis of the load, which is open load, short to GND as well as short circuit to  $V_{bat}$  detection and over load / over temperature indication. The SPI diagnosis flags indicate latched fault conditions that may have occurred.

Each output stage is protected against short circuit. In case of over load, the current of the affected channel is limited. There is a temperature sensor available for each channel to protect the device in case of over temperature. The shut down behavior in case of over load or over temperature can be configured via SPI for each channel individually.

### 1.1 Block Diagram

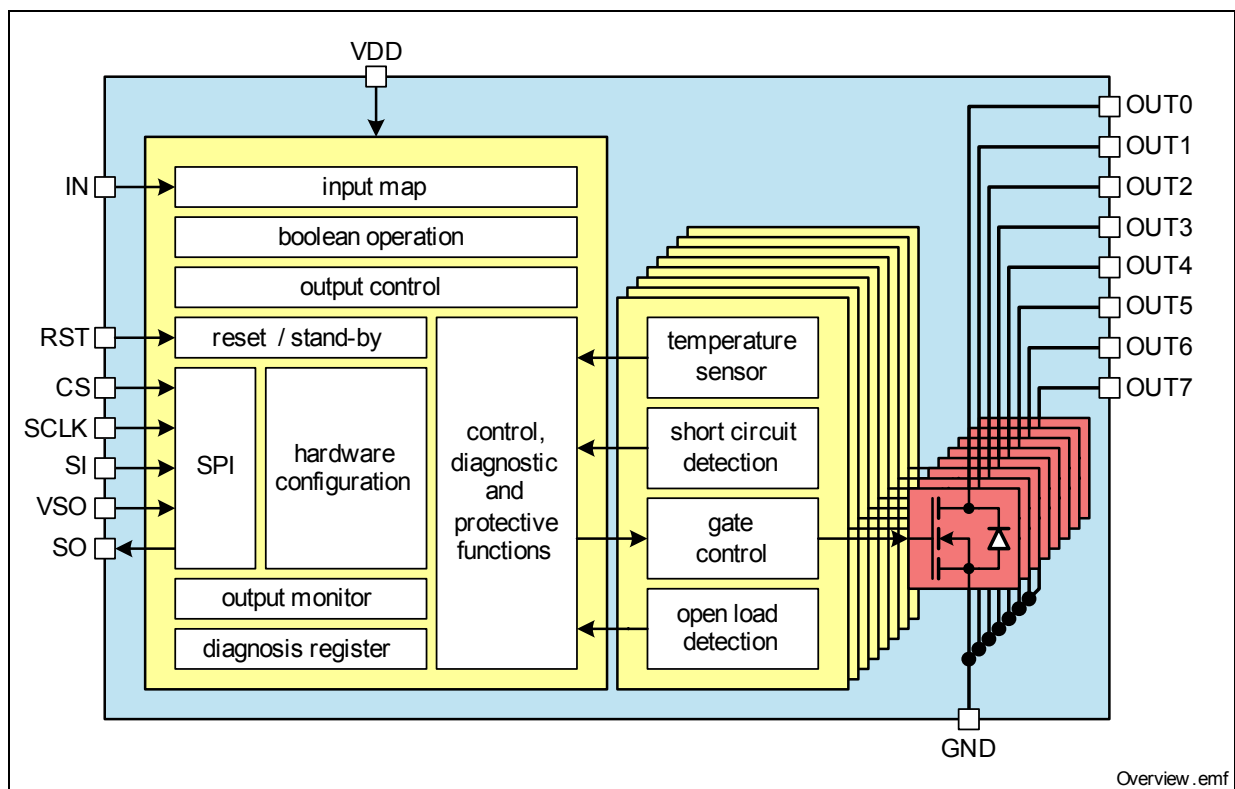
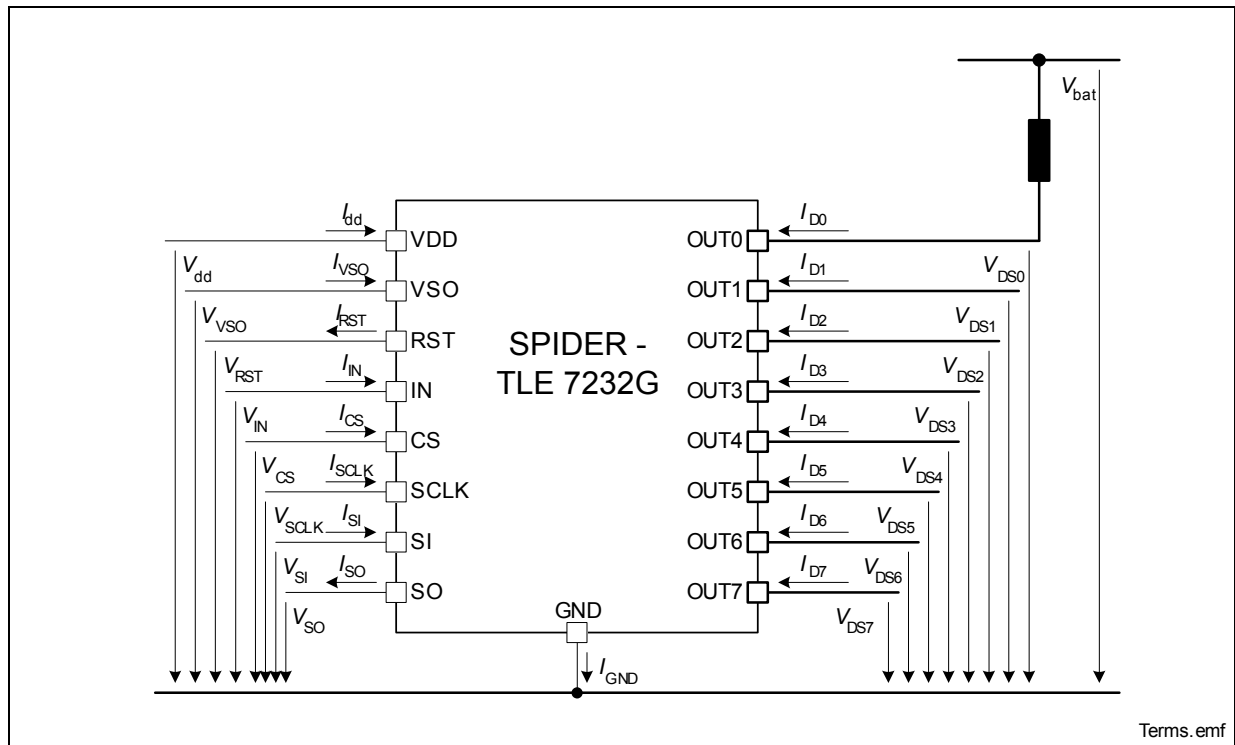


Figure 1 Block Diagram

## 1.2 Terms

Following figure shows all terms used in this data sheet.



**Figure 2 Terms**

In all tables of electrical characteristics is valid: Channel related symbols without channel number are valid for each channel separately (e.g.  $V_{DS}$  specification is valid for  $V_{DS0} \dots V_{DS7}$ ).

All SPI register bits are marked as follows: ADDR.PARAMETER (e.g. CTL.OUT0). In SPI register description, the values in bold letters (e.g. **0**) are default values.

## 2 Pin Configuration

### 2.1 Pin Assignment SPIDER - TLE 7232G

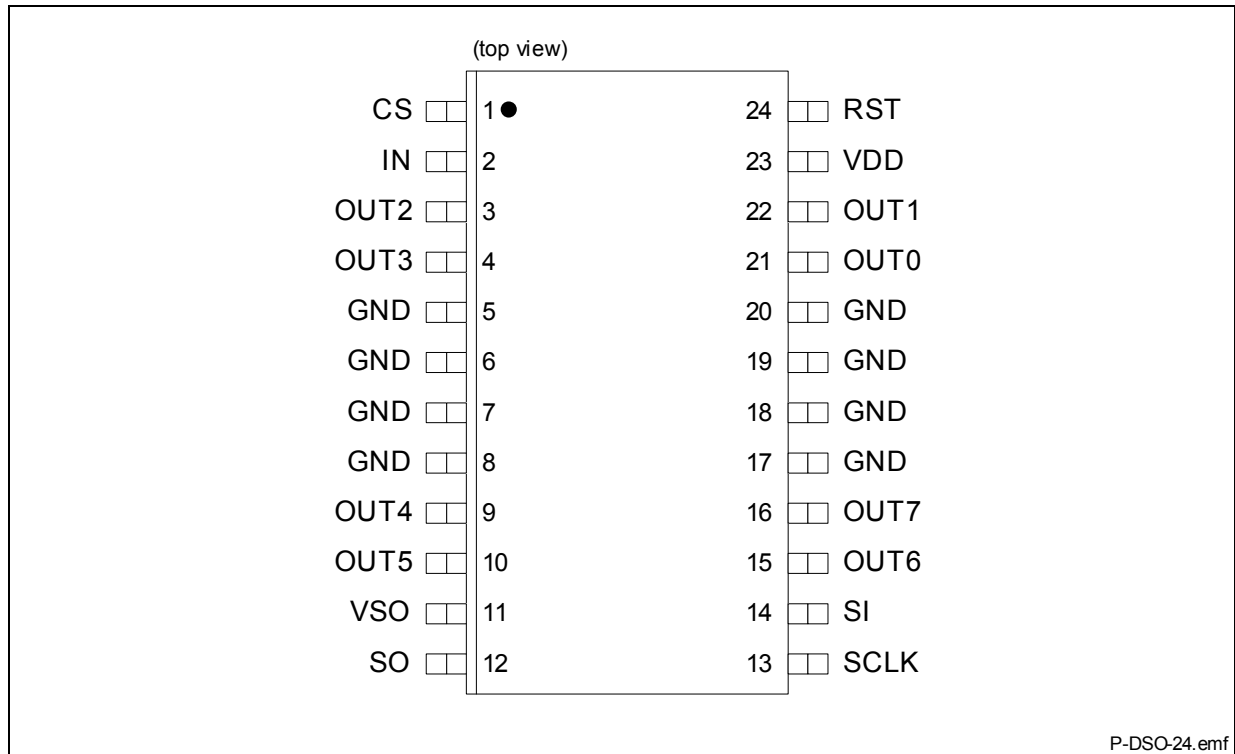


Figure 3 Pin Configuration P-DSO-24-3

### 2.2 Pin Definitions and Functions

Pin	Symbol	I/O	Function
<b>Power Supply</b>			
23	VDD	–	Power supply
11	VSO	–	Power supply for SO buffer
5, 6, 7, 8, 17, 18, 19, 20	GND	–	Ground
<b>Power Stages</b>			
21	OUT0	O	Drain of power transistor channel 0
22	OUT1	O	Drain of power transistor channel 1
3	OUT2	O	Drain of power transistor channel 2

**Pin Configuration**

Pin	Symbol	I/O	Function
4	OUT3	O	Drain of power transistor channel 3
9	OUT4	O	Drain of power transistor channel 4
10	OUT5	O	Drain of power transistor channel 5
15	OUT6	O	Drain of power transistor channel 6
16	OUT7	O	Drain of power transistor channel 7

**Inputs**

24	RST	I	Reset input pin (active low)
2	IN	I	Input multiplexer input pin

**SPI**

1	CS	I	SPI Chip select (active low)
13	SCLK	I	Serial clock
14	SI	I	Serial data in
12	SO	O	Serial data out



### 3 Electrical Characteristics

#### 3.1 Maximum Ratings

Stresses above the ones listed here may affect device reliability or may cause permanent damage to the device.

Unless otherwise specified:  $V_{dd} = 4.5 \text{ V to } 5.5 \text{ V}$ ,  $T_j = -40 \text{ }^\circ\text{C to } 150 \text{ }^\circ\text{C}$

Pos.	Parameter	Symbol	Limit Values		Unit	Test Conditions
			min.	max.		

#### Power Supply

3.1.1	Power supply voltage	$V_{dd}$	-0.3	5.5	V	
3.1.2	VSO supply voltage	$V_{VSO}$	-0.3	$V_{dd} + 0.3$	V	1)
3.1.3	Power supply voltage for full short circuit protection (single pulse)	$V_{bat(SC)}$	0	20 28	V	OVL = 0 <sup>2)</sup> OVL = 1

#### Power Stages

3.1.4	Load current	$I_D$	-1	1	A		
3.1.5	Voltage at power transistor	$V_{DS}$		48	V		
3.1.6	Maximum energy dissipation one channel single pulse	$E_{AS}$		65	mJ	<sup>3)</sup> $T_{j(0)} = 85 \text{ }^\circ\text{C}$ $I_{D(0)} = 0.35 \text{ A}$ $T_{j(0)} = 150 \text{ }^\circ\text{C}$ $I_{D(0)} = 0.25 \text{ A}$	
				30			
	Maximum energy dissipation one channel repetitive pulses	$E_{AR}$			mJ	<sup>3)</sup> $T_{j(0)} = 150 \text{ }^\circ\text{C}$ $I_{D(0)} = 0.20 \text{ A}$ $I_{D(0)} = 0.17 \text{ A}$	
				1 · 10 <sup>4</sup> cycles			18
				1 · 10 <sup>6</sup> cycles			13

#### Logic Pins

3.1.7	Voltage at input pin	$V_{IN}$	-0.3	5.5	V	
3.1.8	Voltage at reset pin	$V_{RST}$	-0.3	5.5	V	
3.1.9	Voltage at chip select pin	$V_{CS}$	-0.3	5.5	V	
3.1.10	Voltage at serial clock pin	$V_{SCLK}$	-0.3	5.5	V	

**Electrical Characteristics**

Unless otherwise specified:  $V_{dd} = 4.5 \text{ V to } 5.5 \text{ V}$ ,  $T_j = -40 \text{ }^\circ\text{C to } 150 \text{ }^\circ\text{C}$

Pos.	Parameter	Symbol	Limit Values		Unit	Test Conditions
			min.	max.		
3.1.11	Voltage at serial input pin	$V_{SI}$	-0.3	5.5	V	
3.1.12	Voltage at serial output pin	$V_{SO}$	-0.3	5.5	V	

**Temperatures**

3.1.13	Junction Temperature	$T_j$	-40	150	$^\circ\text{C}$	
3.1.14	Dynamic temperature increase while switching	$\Delta T_j$		60	$^\circ\text{C}$	
3.1.15	Storage Temperature	$T_{stg}$	-55	150	$^\circ\text{C}$	

**ESD Susceptibility**

3.1.16	ESD susceptibility HBM	$V_{ESD}$	-2	2	kV	according to EIA/JESD 22-A 114B
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1)  $V_{dd} + 0.3 \text{ V} < 5.5 \text{ V}$

2) Details on configuration of protective function OLCR.OVL can be found in [Section 4.2.5](#)

3) Pulse shape represents inductive switch off:  $I_D(t) = I_D(0) \times (1 - t / t_{pulse})$ ;  $0 < t < t_{pulse}$

## 4 Block Description and Electrical Characteristics

### 4.1 Power Stages

The SPIDER - TLE 7232G is an eight channel low-side relay switch. The power stages are built by N-channel vertical power MOSFET transistors.

#### 4.1.1 Power Supply

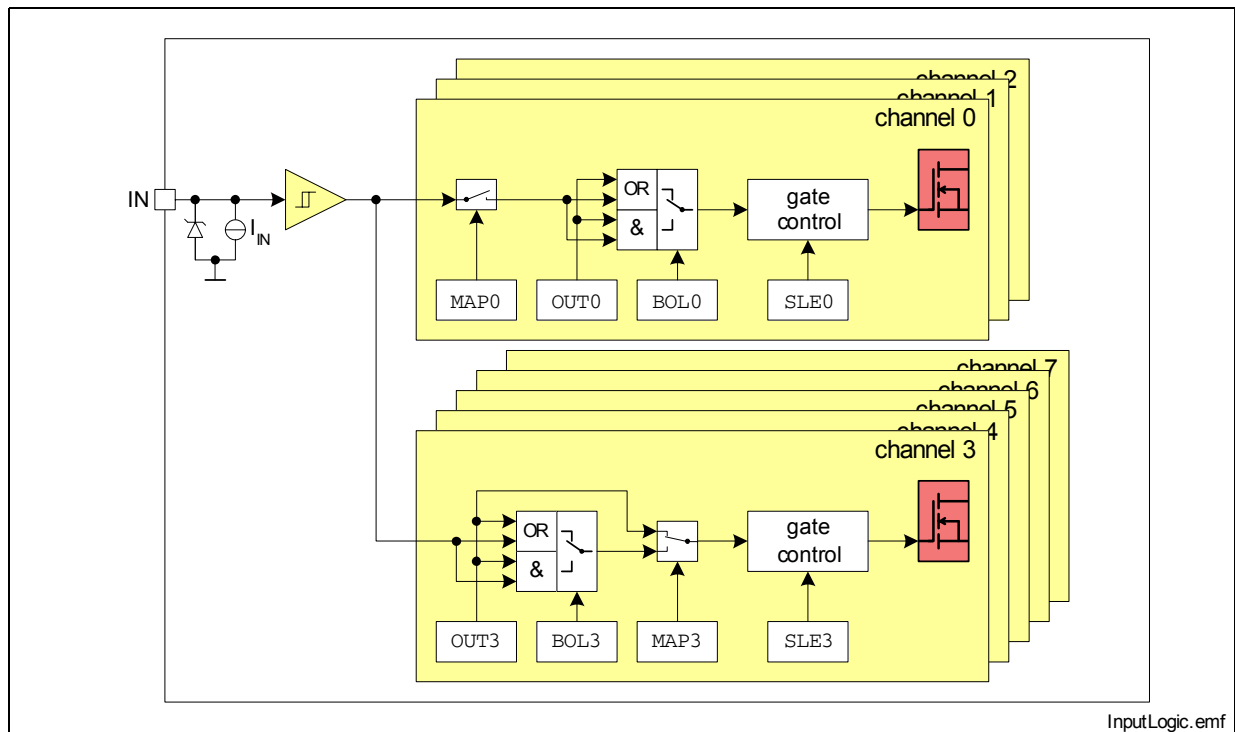
The SPIDER - TLE 7232G is supplied by power supply line  $V_{dd}$  which is used for the digital as well as the analog functions of the device including the gate control of the power stages. There is a power-on reset function implemented for the supply line. After start-up of the power supply, all SPI registers are reset to their default values. A capacitor at pins VDD to GND is recommended.

The voltage at pin VSO is used by the driver of the SO line at the SPI. It is designed to be functional at a wide voltage range.

There is a reset pin available. At low level at this pin, all registers are set to their default values and the quiescent supply current is minimized.

#### 4.1.2 Input Circuit

There is an input pin available at SPIDER - TLE 7232G to control the output stages.



**Figure 4 Input Mapping and Boolean Operator**

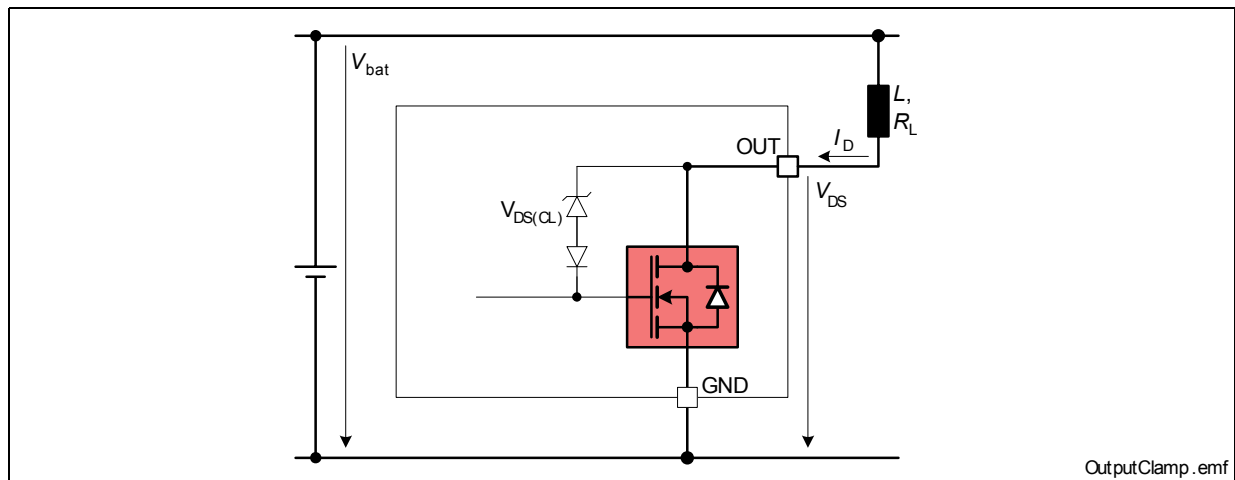
**Block Description and Electrical Characteristics**

The input signal can be configured to be used as control signal of the output stages for each channel separately. The channels 0 to 3 differ from the channels 4 to 7 in the mapping behavior. Please refer to **Figure 4** for details.

The current sink to ground at the input pin ensures that the channels switch off in case of open pin. The zener diode protects the input circuit against ESD pulses.

### 4.1.3 Inductive Output Clamp

When switching off inductive loads, the potential at pin OUT rises to  $V_{DS(CL)}$  potential, because the inductance intends to continue driving the current. The voltage clamping is necessary to prevent destruction of the device, see **Figure 5** for details. Nevertheless, the maximum allowed load inductance is limited.



**Figure 5 Output Clamp Implementation**

### Maximum Load Inductance

During demagnetization of inductive loads, energy has to be dissipated in the SPIDER - TLE 7232G. This energy can be calculated with following equation:

$$E = V_{DS(CL)} \cdot \left[ \frac{V_{bat} - V_{DS(CL)}}{R_L} \cdot \ln \left( 1 - \frac{R_L \cdot I_D}{V_{bat} - V_{DS(CL)}} \right) + I_D \right] \cdot \frac{L}{R_L} \quad (1)$$

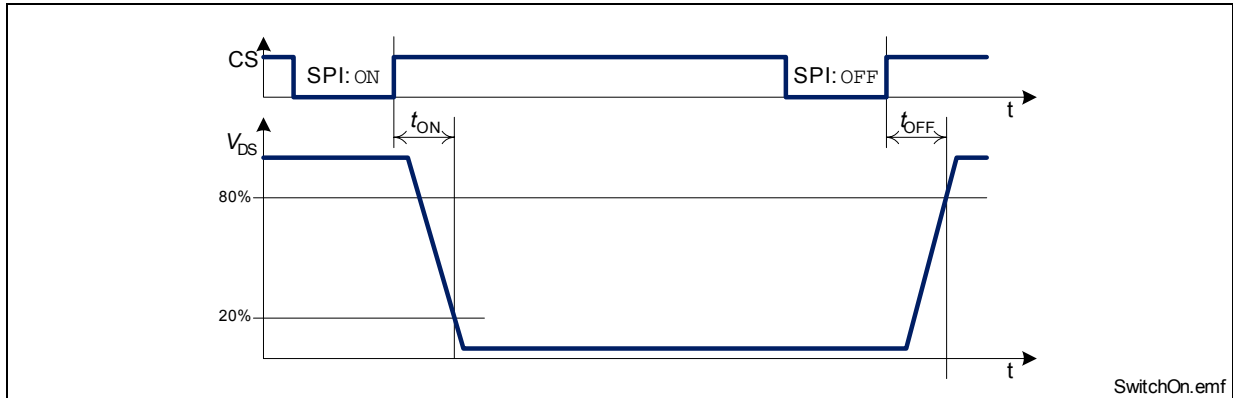
The equation simplifies under the assumption of  $R_L = 0$ :

$$E = \frac{1}{2} L I_D^2 \cdot \left( 1 - \frac{V_{bat}}{V_{bat} - V_{DS(CL)}} \right) \quad (2)$$

The energy, which is converted into heat, is limited by the thermal design of the component.

#### 4.1.4 Timing Diagrams

The power transistors are switched on and off with a dedicated slope via the `OUT` bits of the serial peripheral interface SPI. The switching times  $t_{ON}$  and  $t_{OFF}$  are designed equally.



**Figure 6 Switching a Resistive Load**

When the input mapping is configured accordingly, a high signal at the input pin is equivalent to a SPI ON command.

**Block Description and Electrical Characteristics**

### 4.1.5 Electrical Characteristics

Unless otherwise specified:  $V_{dd} = 4.5 \text{ V to } 5.5 \text{ V}$ ,  $T_j = -40 \text{ °C to } 150 \text{ °C}$   
 typical values:  $V_{dd} = 5.0 \text{ V}$ ,  $T_j = 25 \text{ °C}$

Pos.	Parameter	Symbol	Limit Values			Unit	Test Conditions
			min.	typ.	max.		

#### Power Supply

4.1.1	Power supply voltage	$V_{dd}$	4.5		5.5	V	
4.1.2	Power supply current	$I_{dd(ON)}$		3	5	mA	all channels ON
4.1.3	Power supply reset current	$I_{dd(RST)}$			10	$\mu\text{A}$	$V_{RST} = 0 \text{ V}$ $V_{IN} = 0 \text{ V}$ $V_{SCLK} = 0 \text{ V}$ $V_{SI} = 0 \text{ V}$ $V_{CS} = V_{dd}$
4.1.4	Power-on reset threshold voltage	$V_{dd(PO)}$			4.5	V	

#### Output Characteristics

4.1.5	On-State resistance per channel	$R_{DS(ON)}$		1.0	1.2 2.1	$\Omega$	$I_L = 300 \text{ mA}$ $V_{dd} = 5 \text{ V}$ $T_j = 25 \text{ °C}^{1)}$ $T_j = 150 \text{ °C}$
4.1.6	Output leakage current in stand-by mode (per channel)	$I_{D(RST)}$			1 2 5	$\mu\text{A}$	$V_{DS} = 13.5 \text{ V}$ $T_j = 25 \text{ °C}^{1)}$ $T_j = 125 \text{ °C}$ $T_j = 150 \text{ °C}^{1)}$
4.1.7	Output clamping voltage	$V_{DS(CL)}$	48		60	V	

#### Input Characteristics

4.1.8	L level of pin IN	$V_{IN(L)}$	0		1.0	V	
4.1.9	H level of pin IN	$V_{IN(H)}$	2.0		$V_{dd}$	V	
4.1.10	Input voltage hysteresis at pin IN	$\Delta V_{IN}$		0.1		V	<sup>1)</sup>
4.1.11	L-input pull-down current through pin IN	$I_{IN(L)}$	10		100	$\mu\text{A}$	<sup>1)</sup> $V_{IN} = 1 \text{ V}$
4.1.12	H-input pull-down current through pin IN	$I_{IN(H)}$	20	50	100	$\mu\text{A}$	$V_{IN} = 5 \text{ V}$

**Block Description and Electrical Characteristics**

Unless otherwise specified:  $V_{dd} = 4.5\text{ V to }5.5\text{ V}$ ,  $T_j = -40\text{ °C to }150\text{ °C}$   
 typical values:  $V_{dd} = 5.0\text{ V}$ ,  $T_j = 25\text{ °C}$

Pos.	Parameter	Symbol	Limit Values			Unit	Test Conditions
			min.	typ.	max.		

**Reset**

4.1.13	L level of pin RST	$V_{RST(L)}$	0		1	V	
4.1.14	H level of pin RST	$V_{RST(H)}$	2		$V_{dd}$	V	
4.1.15	L-input pull-up current through pin RST	$I_{RST(L)}$	0		10	$\mu\text{A}$	$V_{RST} = 1\text{ V}$
4.1.16	H-input pull-up current through pin RST	$I_{RST(H)}$	20	50	100	$\mu\text{A}$	$V_{RST} = 2\text{ V}$

**Thermal Resistance**

4.1.17	Junction to ambient all channels active	$R_{thja}$		75		K/W	1) 2)
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**Timings**

4.1.18	Power-on wake up time	$t_{wu(PO)}$			200	$\mu\text{s}$	
4.1.19	Reset duration	$t_{RST(L)}$	10			$\mu\text{s}$	
4.1.20	Turn-on time $V_{DS} = 20\% V_{bat}$	$t_{ON}$			15 60	$\mu\text{s}$	$V_{bat} = 14\text{ V}$ $I_{DS} = 300\text{ mA}$ , resistive load SLE = 0 SLE = 1
4.1.21	Turn-off time $V_{DS} = 80\% V_{bat}$	$t_{OFF}$			15 60	$\mu\text{s}$	$V_{bat} = 14\text{ V}$ $I_{DS} = 300\text{ mA}$ , resistive load SLE = 0 SLE = 1

1) Not subject to production test, specified by design

2) Device mounted on PCB (100 mm × 100 mm × 1.5 mm). PCB without blown air. All channels with balanced loads.

*Note: Characteristics show the deviation of parameter at the given supply voltage and junction temperature. Typical values show the typical parameters expected from manufacturing.*

**Block Description and Electrical Characteristics**

### 4.1.6 Command Description

#### IMCR

#### Input Mapping Configuration Register

**Reset Value: 08<sub>H</sub>**

7	6	5	4	3	2	1	0
<b>MAP7</b>	<b>MAP6</b>	<b>MAP5</b>	<b>MAP4</b>	<b>MAP3</b>	<b>MAP2</b>	<b>MAP1</b>	<b>MAP0</b>
rw	rw	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
MAPn (n = 7-0)	n	rw	<b>Input Mapping Configuration Channel n</b> 0 Channel n can not be controlled with input pin (default value). 1 Channel n can be controlled with input pin, depending on additional set-up.

#### BOCR

#### Boolean Operator Configuration Register

**Reset Value: 00<sub>H</sub>**

7	6	5	4	3	2	1	0
<b>BOL7</b>	<b>BOL6</b>	<b>BOL5</b>	<b>BOL4</b>	<b>BOL3</b>	<b>BOL2</b>	<b>BOL1</b>	<b>BOL0</b>
rw	rw	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
BOLn (n = 7-0)	n	rw	<b>Boolean Operator Configuration Channel n</b> 0 Logic "OR" for channel n (default value). 1 Logic "AND" for channel n.



**Block Description and Electrical Characteristics**

**SRCR**

**Slew Rate Configuration Register**

**Reset Value: 00<sub>H</sub>**

7	6	5	4	3	2	1	0
<b>SLE7</b>	<b>SLE6</b>	<b>SLE5</b>	<b>SLE4</b>	<b>SLE3</b>	<b>SLE2</b>	<b>SLE1</b>	<b>SLE0</b>
rW	rW	rW	rW	rW	rW	rW	rW

Field	Bits	Type	Description
SLEn (n = 7-0)	n	rW	<b>Slew Rate Configuration Channel n</b> 0 Channel n is switched fast (default value). 1 Channel n is switched slowly.

**CTL**

**Output Control Register**

**Reset Value: 00<sub>H</sub>**

7	6	5	4	3	2	1	0
<b>OUT7</b>	<b>OUT6</b>	<b>OUT5</b>	<b>OUT4</b>	<b>OUT3</b>	<b>OUT2</b>	<b>OUT1</b>	<b>OUT0</b>
rW	rW	rW	rW	rW	rW	rW	rW

Field	Bits	Type	Description
OUTn (n = 7-0)	n	rW	<b>Output Control Channel n</b> 0 Channel n is switched off (default value). 1 Channel n is switched on, depending on additional set-up.

## 4.2 Protection Functions

The device provides embedded protective functions. Integrated protection functions are designed to prevent IC destruction under fault conditions described in this data sheet. Fault conditions are considered as “outside” normal operating range. Protection functions are not designed for continuous repetitive operation.

There is an over load and over temperature protection implemented in the SPIDER - TLE 7232G. The behavior of the protective functions can be set-up via SPI. Following figure gives an overview about the protective functions.

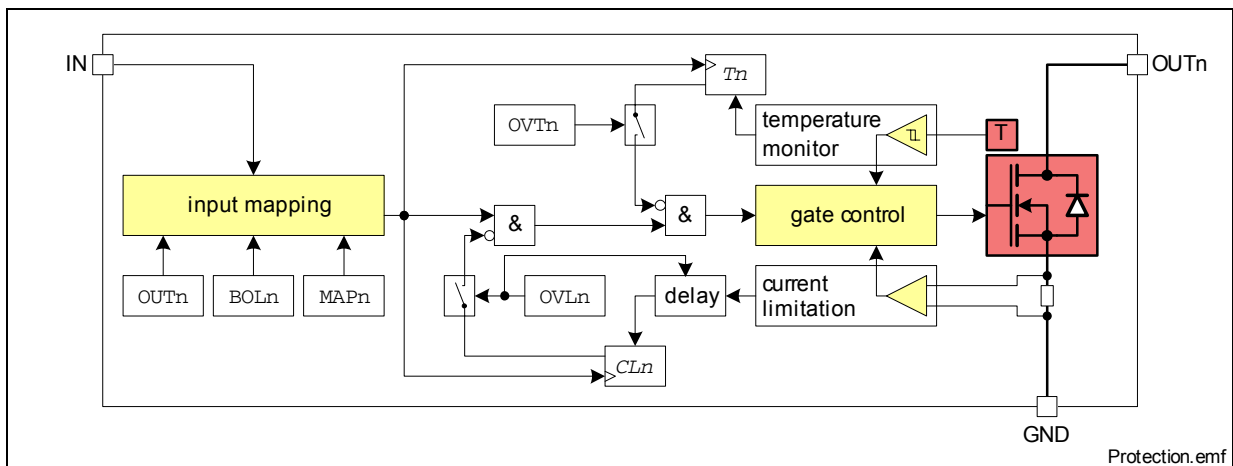


Figure 7 Protective Functions

### 4.2.1 Over Load Protection

The SPIDER - TLE 7232G is protected in case of over load or short circuit of the load. The behavior in case of over load can be configured as follows:

- The current is limited to  $I_{DS(LIM)}$ . After time  $t_{d(fault)}$ , the according over load flag  $L_n$  is set. The channel may shut down due to over temperature.
- The current is limited to  $I_{DS(LIM)}$ . After time  $t_{d(off)}$ , the over loaded channel  $n$  switches off and the according over load flag  $L_n$  is set.

The over load flag ( $CL_n$ ) of the affected channel is cleared by a low-high transition of the input signal. For timing information, please refer to [Figure 8](#) for details.

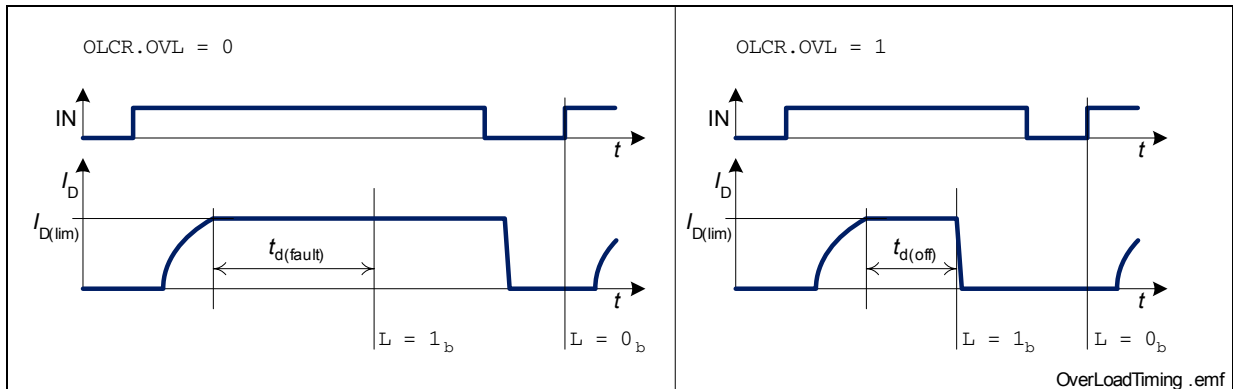


Figure 8 Over Load Behavior

#### 4.2.2 Over Temperature Protection

A temperature sensor for each channel causes an overheated channel  $\tau$  to switch off immediately to prevent destruction. The behavior in case of over temperature can be configured as follows:

- After cooling down, the channel is switched on again with thermal hysteresis  $\Delta T_j$ .
- The affected channel stays switched off until the over temperature flag is cleared.

The over temperature flag of the affected channel is cleared by a low-high transition of the input signal.

#### 4.2.3 Reverse Polarity Protection

In case of reverse polarity, the intrinsic body diode of the power transistor causes power dissipation. The reverse current through the intrinsic body diode has to be limited by the connected load. The  $V_{dd}$  supply pin must be protected against reverse polarity externally. The over-temperature protection as well as other protective functions are not active during reverse polarity.

#### 4.2.4 Electrical Characteristics

Unless otherwise specified:  $V_{dd} = 4.5 \text{ V to } 5.5 \text{ V}$ ,  $T_j = -40 \text{ °C to } 150 \text{ °C}$   
typical values:  $V_{dd} = 5.0 \text{ V}$ ,  $T_j = 25 \text{ °C}$

Pos.	Parameter	Symbol	Limit Values			Unit	Test Conditions
			min.	typ.	max.		
<b>Over Load Protection</b>							
4.2.1	Over load current limitation	$I_{D(lim)}$	1		2	A	OVL = 0
4.2.2	Over load shut-down delay time	$t_{d(off)}$	10		50	$\mu\text{s}$	OVL = 1
<b>Over Temperature Protection</b>							
4.2.3	Over temperature shut-down threshold	$T_{j(OT)}$	170		200	$^{\circ}\text{C}$	1)
4.2.4	Thermal hysteresis	$\Delta T_{j(OT)}$		10		K	1)

1) Not subject to production test, specified by design

#### 4.2.5 Command Description

##### OLCR

##### Over Load Configuration Register

Reset Value: 00<sub>H</sub>

7	6	5	4	3	2	1	0
<b>OVL7</b>	<b>OVL6</b>	<b>OVL5</b>	<b>OVL4</b>	<b>OVL3</b>	<b>OVL2</b>	<b>OVL1</b>	<b>OVL0</b>
rw	rw	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
OVLn (n = 7-0)	n	rw	<b>Over Load Configuration Channel n</b> 0 Channel n limits the current in case of over load (default value). 1 Channel n shuts down in case of over load.

##### OTCR

##### Over Temperature Configuration Register

Reset Value: 00<sub>H</sub>

7	6	5	4	3	2	1	0
<b>OVT7</b>	<b>OVT6</b>	<b>OVT5</b>	<b>OVT4</b>	<b>OVT3</b>	<b>OVT2</b>	<b>OVT1</b>	<b>OVT0</b>
rw	rw	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
OVTn (n = 7-0)	n	rw	<b>Over Temperature Configuration Channel n</b> 0 Autorestart (default value) 1 Latched shut down

### 4.3 Diagnostic Features

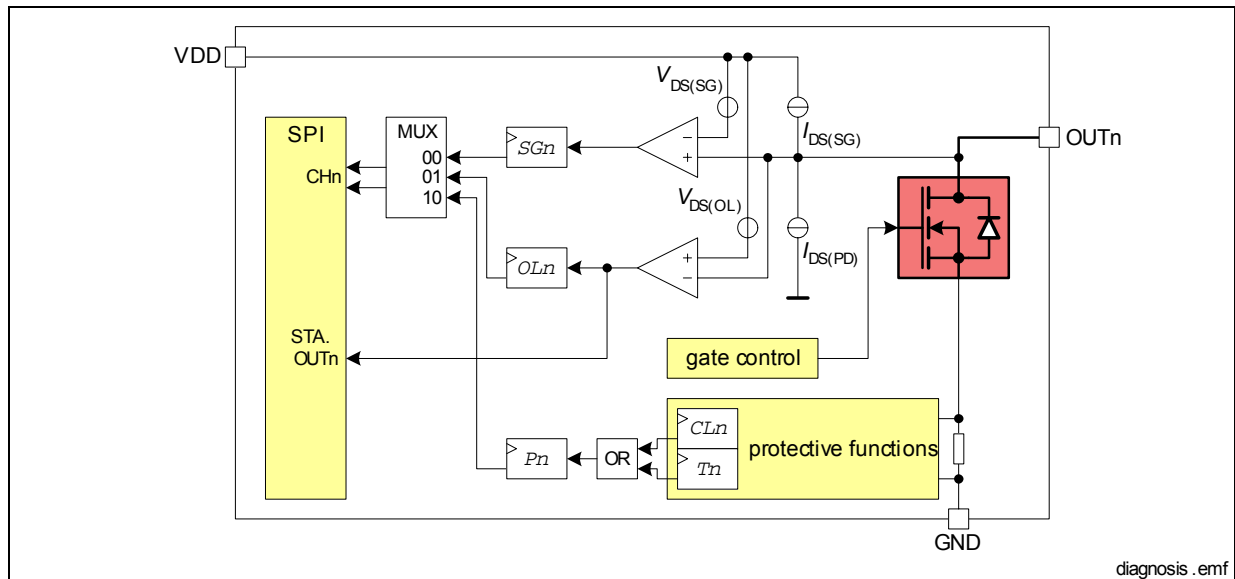
The SPI of SPIDER - TLE 7232G provides diagnosis information about the device and about the load. There are following diagnosis flags implemented:

- The diagnosis information of the protective functions (flags  $CLn$  and  $Tn$ ) of channel  $n$  is latched in the diagnosis flag  $Pn$ .
- The open load diagnosis of channel  $n$  is latched in the diagnosis flag  $OLn$ .
- The short to gnd monitor information of channel  $n$  is latched in the diagnosis flag  $SGn$ .

All flags are cleared after a successful SPI transmission.

There is an output state monitor implemented in the device that indicates the switch state of the device in register  $STA$ . Depending on the voltage level at input pin and protective functions the bits are high or low.

Please see **Figure 9** for details:



**Figure 9** Block Diagram Diagnosis

### 4.3.1 Electrical Characteristics

Unless otherwise specified:  $V_{dd} = 4.5 \text{ V to } 5.5 \text{ V}$ ,  $T_j = -40 \text{ }^\circ\text{C to } 150 \text{ }^\circ\text{C}$   
typical values:  $V_{dd} = 5.0 \text{ V}$ ,  $T_j = 25 \text{ }^\circ\text{C}$

Pos.	Parameter	Symbol	Limit Values			Unit	Test Conditions
			min.	typ.	max.		
<b>OFF State Diagnosis</b>							
4.3.1	Open load detection threshold voltage	$V_{DS(OL)}$	$V_{dd} - 2.5$	$V_{dd} - 2$	$V_{dd} - 1.3$	V	
4.3.2	Output pull-down diagnosis current per channel	$I_{D(PD)}$	50	90	150	$\mu\text{A}$	
4.3.3	Short to gnd detection threshold voltage	$V_{DS(SG)}$	$V_{dd} - 3.4$	$V_{dd} - 3.0$	$V_{dd} - 2.6$	V	
4.3.4	Output diagnosis current for short to gnd per channel	$I_{D(SG)}$	-150	-100	-50	$\mu\text{A}$	$V_{DS} = 0 \text{ V}$
4.3.5	Fault delay time	$t_{d(\text{fault})}$	50	100	200	$\mu\text{s}$	

### 4.3.2 Command Description

#### STA

#### Output Status Monitor

Reset Value: 00<sub>H</sub>

7	6	5	4	3	2	1	0
OUT7	OUT6	OUT5	OUT4	OUT3	OUT2	OUT1	OUT0
r	r	r	r	r	r	r	r

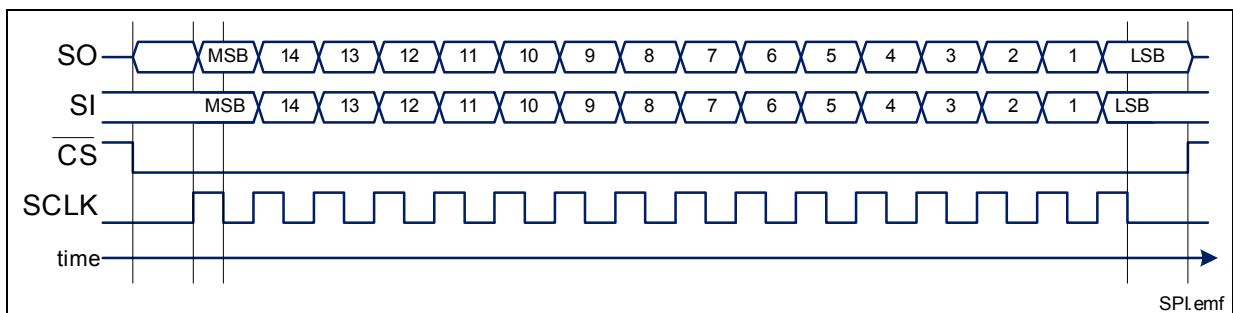
Field	Bits	Type	Description
OUTn (n = 7-0)	n	r	<b>Output Status</b> 0 Voltage level at channel n: $V_{DS} > V_{DS(OL)}$ . 1 Voltage level at channel n: $V_{DS} < V_{DS(OL)}$ .



## 4.4 Serial Peripheral Interface (SPI)

The diagnosis and control interface is based on a serial peripheral interface (SPI).

The SPI is a full duplex synchronous serial slave interface, which uses four lines: SO, SI, SCLK and  $\overline{\text{CS}}$ . Data is transferred by the lines SI and SO at the data rate given by SCLK. The falling edge of  $\overline{\text{CS}}$  indicates the beginning of a data access. Data is sampled in on line SI at the falling edge of SCLK and shifted out on line SO at the rising edge of SCLK. Each access must be terminated by a rising edge of  $\overline{\text{CS}}$ . A modulo 8 counter ensures that data is taken only, when a multiple of 8 bit has been transferred. The interface provides daisy chain capability.



**Figure 10** Serial Peripheral Interface

The SPI protocol is described in [Section 4.4.5](#). It is reset to the default values after power-on reset or a low signal at pin RST.

### 4.4.1 SPI Signal Description

**$\overline{\text{CS}}$  - Chip Select:** The system micro controller selects the SPIDER - TLE 7232G by means of the  $\overline{\text{CS}}$  pin. Whenever the pin is in low state, data transfer can take place. When  $\overline{\text{CS}}$  is in high state, any signals at the SCLK and SI pins are ignored and SO is forced into a high impedance state.

**$\overline{\text{CS}}$  High to Low transition:** 

- The diagnosis information is transferred into the shift register.

**$\overline{\text{CS}}$  Low to High transition:** 

- Command decoding is only done, when after the falling edge of  $\overline{\text{CS}}$  exactly a multiple (1, 2, 3, ...) of eight SCLK signals have been detected.
- Data from shift register is transferred into the input matrix register.
- The diagnosis flags are cleared.

**SCLK - Serial Clock:** This input pin clocks the internal shift register. The serial input (SI) transfers data into the shift register on the falling edge of SCLK while the serial output

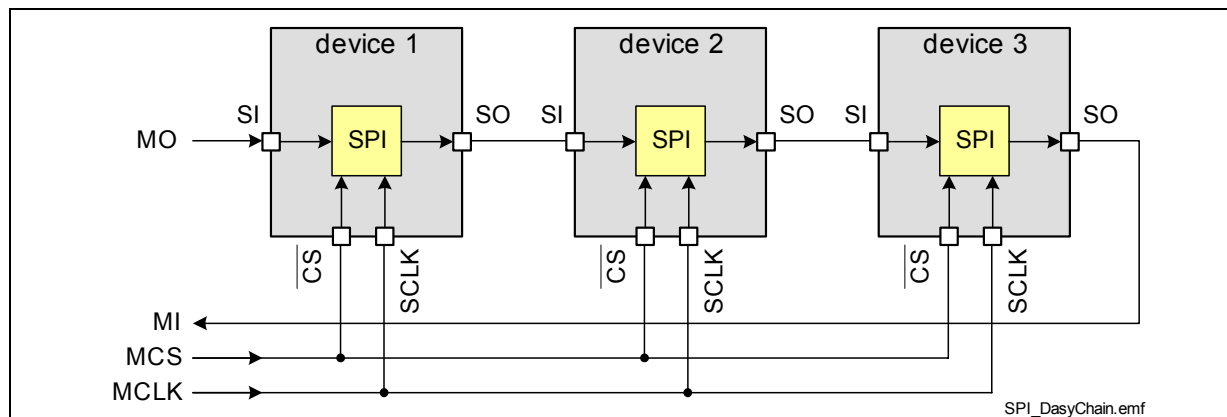
(SO) shifts diagnostic information out on the rising edge of the serial clock. It is essential that the SCLK pin is in low state whenever chip select  $\overline{CS}$  makes any transition.

**SI - Serial Input:** Serial input data bits are shifted in at this pin, the most significant bit first. SI information is read on the falling edge of SCLK. The 16 bit input data consist of two parts (control and data). Please refer to [Section 4.4.5](#) for further information.

**SO Serial Output:** Data is shifted out serially at this pin, the most significant bit first. SO is in high impedance state until the  $\overline{CS}$  pin goes to low state. New data will appear at the SO pin following the rising edge of SCLK. Please refer to [Section 4.4.5](#) for further information.

### 4.4.2 Daisy Chain Capability

The SPI of SPIDER - TLE 7232G provides daisy chain capability. In this configuration several devices are activated by the same  $\overline{CS}$  signal  $\overline{MCS}$ . The SI line of one device is connected with the SO line of another device (see [Figure 11](#)), which builds a chain. The ends of the chain are connected with the output and input of the master device, MO and MI respectively. The master device provides the master clock MCLK, which is connected to the SCLK line of each device in the chain.



**Figure 11 Daisy Chain Configuration**

In the SPI block of each device, there is one shift register where one bit from SI line is shifted in each SCLK. The bit shifted out can be seen at SO. After 16 SCLK cycles, the data transfer for one device has been finished. In single chip configuration, the  $\overline{CS}$  line must go high to make the device accept the transferred data. In daisy chain configuration the data shifted out at device #1 has been shifted in to device #2. When using three devices in daisy chain, three times 16 bits have to be shifted through the devices. After that, the  $\overline{MCS}$  line must go high (see [Figure 12](#)).

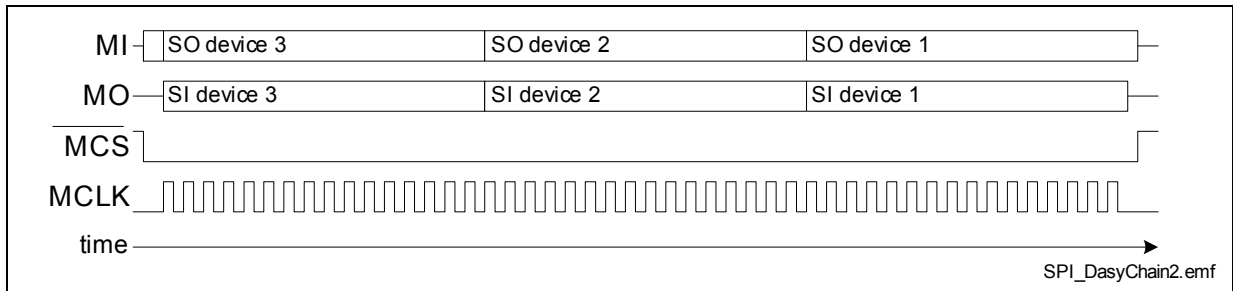


Figure 12 Data Transfer in Daisy Chain Configuration

#### 4.4.3 Timing Diagrams

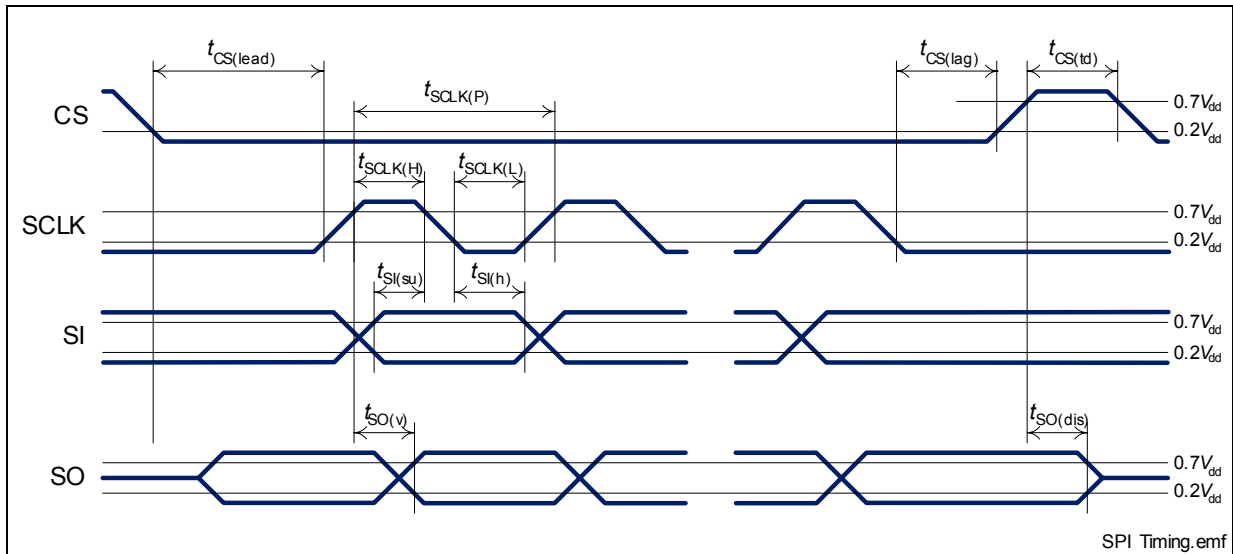


Figure 13 Timing Diagram

#### 4.4.4 Electrical Characteristics

Unless otherwise specified:

$V_{VSO} = 3.0\text{ V to }5.5\text{ V}$ ,  $V_{dd} = 4.5\text{ V to }5.5\text{ V}$ ,  $T_j = -40\text{ °C to }150\text{ °C}$

typical values:  $V_{VSO} = 5.0\text{ V}$ ,  $V_{dd} = 5.0\text{ V}$ ,  $T_j = 25\text{ °C}$

Pos.	Parameter	Symbol	Limit Values			Unit	Test Conditions
			min.	typ.	max.		
<b>Power Supply</b>							
4.4.1	Power supply voltage for SO buffer	$V_{VSO}$	3.0		5.5	V	
<b>Input Characteristics (CS, SCLK, SI)</b>							
4.4.2	L level of pin $\overline{\text{CS}}$ SCLK SI	$V_{CS(L)}$ $V_{SCLK(L)}$ $V_{SI(L)}$	0		1	V	
4.4.3	H level of pin $\overline{\text{CS}}$ SCLK SI	$V_{CS(H)}$ $V_{SCLK(H)}$ $V_{SI(H)}$	2		$V_{dd}$	V	
4.4.4	L-input pull-up current through $\overline{\text{CS}}$	$I_{CS(L)}$	10	20	50	$\mu\text{A}$	$V_{CS} = 0\text{ V}$
4.4.5	H-input pull-up current through $\overline{\text{CS}}$	$I_{CS(H)}$	5		50	$\mu\text{A}$	<sup>1)</sup> $V_{CS} = 2\text{ V}$
4.4.6	L-input pull-down current through pin SCLK SI	$I_{SCLK(L)}$ $I_{SI(L)}$	5		50	$\mu\text{A}$	<sup>1)</sup> $V_{SCLK} = 1\text{ V}$ $V_{SI} = 1\text{ V}$
4.4.7	H-input pull-down current through pin SCLK SI	$I_{SCLK(H)}$ $I_{SI(H)}$	10	20	50	$\mu\text{A}$	$V_{SCLK} = 5\text{ V}$ $V_{SI} = 5\text{ V}$
<b>Output Characteristics (SO)</b>							
4.4.8	L level output voltage	$V_{SO(L)}$	0		0.4	V	$I_{SO} = -2.5\text{ mA}$
4.4.9	H level output voltage	$V_{SO(H)}$	4.6 2.4		5 3		$I_{SO} = 2\text{ mA}$ $V_{VSO} = 5\text{ V}$ $V_{VSO} = 3\text{ V}$
4.4.10	Output tristate leakage current	$I_{SO(OFF)}$	-10		10	$\mu\text{A}$	$V_{CS} = V_{dd}$

Unless otherwise specified:

$V_{VSO} = 3.0\text{ V to }5.5\text{ V}$ ,  $V_{dd} = 4.5\text{ V to }5.5\text{ V}$ ,  $T_j = -40\text{ °C to }150\text{ °C}$

typical values:  $V_{VSO} = 5.0\text{ V}$ ,  $V_{dd} = 5.0\text{ V}$ ,  $T_j = 25\text{ °C}$

Pos.	Parameter	Symbol	Limit Values			Unit	Test Conditions
			min.	typ.	max.		

**Timings**

4.4.11	Serial clock frequency	$f_{SCLK}$	0		5	MHz	
4.4.12	Serial clock period	$t_{SCLK(P)}$	200			ns	
4.4.13	Serial clock high time	$t_{SCLK(H)}$	50			ns	
4.4.14	Serial clock low time	$t_{SCLK(L)}$	50			ns	
4.4.15	Enable lead time (falling $\overline{CS}$ to rising SCLK)	$t_{SCLK(lead)}$	250			ns	
4.4.16	Enable lag time (falling SCLK to rising $\overline{CS}$ )	$t_{SCLK(lag)}$	250			ns	
4.4.17	Transfer delay time (rising $\overline{CS}$ to falling $\overline{CS}$ )	$t_{CS(del)}$	250			ns	
4.4.18	Data setup time (required time SI to falling SCLK)	$t_{SI(su)}$	20			ns	
4.4.19	Data hold time (falling SCLK to SI)	$t_{SI(h)}$	20			ns	
4.4.20	Output disable time (rising $\overline{CS}$ to SO tri-state)	$t_{SO(dis)}$			150	ns	<sup>1)</sup>
4.4.21	Output data valid time with capacitive load	$t_{SO(v)}$			100	ns	$C_L = 50\text{ pF}$ <sup>1)</sup>

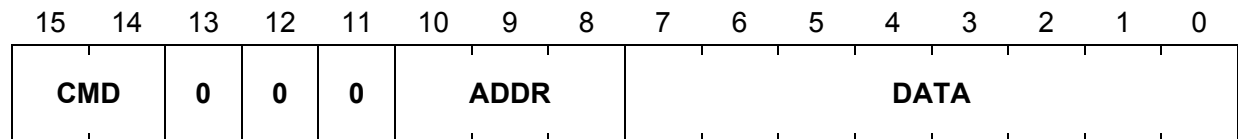
1) Not subject to production test, specified by design.

#### 4.4.5 SPI Protocol

The SPI protocol of the SPIDER - TLE 7232G provides two types of registers. The control registers and the diagnosis registers. After power-on reset, all register bits set to default values.

#### SI

**Reset Value: xxxx<sub>H</sub>**



Field	Bits	Type	Description
CMD	15:14		<b>Command</b> 00 Diagnosis only: The requested data is shifted out at SO. This command does not change any register setting. 01 Read register: The register content of the addressed register will be sent in the next frame. 10 Reset registers: All registers are reset to their default values. 11 Write register: The data of the SI word will be written to the addressed register.
ADDR	10:8		<b>Address</b> Pointer to register for read and write command
DATA	7:0		<b>Data</b> Data written to or read from register selected by address ADDR

**SO**

**Standard Diagnosis**

**Reset Value: xxxx<sub>H</sub>**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0								
CH7			CH6			CH5			CH4			CH3			CH2			CH1			CH0		

Field	Bits	Type	Description
CHn (n = 7-0)	(2n+1): 2n		<b>Standard Diagnosis for Channel n</b> 00 Short circuit to GND 01 Open load 10 Over load, over temperature 11 Normal operation

**SO**

**Second Frame of Read Command**

**Reset Value: xxxx<sub>H</sub>**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	0	ADDR			DATA							

Field	Bits	Type	Description
ADDR	10:8		<b>Address</b> Pointer to register for read and write command
DATA	7:0		<b>Data</b> Data written to or read from register selected by address ADDR

*Note: Reading a register needs two SPI frames. In the first frame the RD command is sent. In the second frame the output at SPI signal SO will contain the requested information. A new command can be executed in the second frame.*

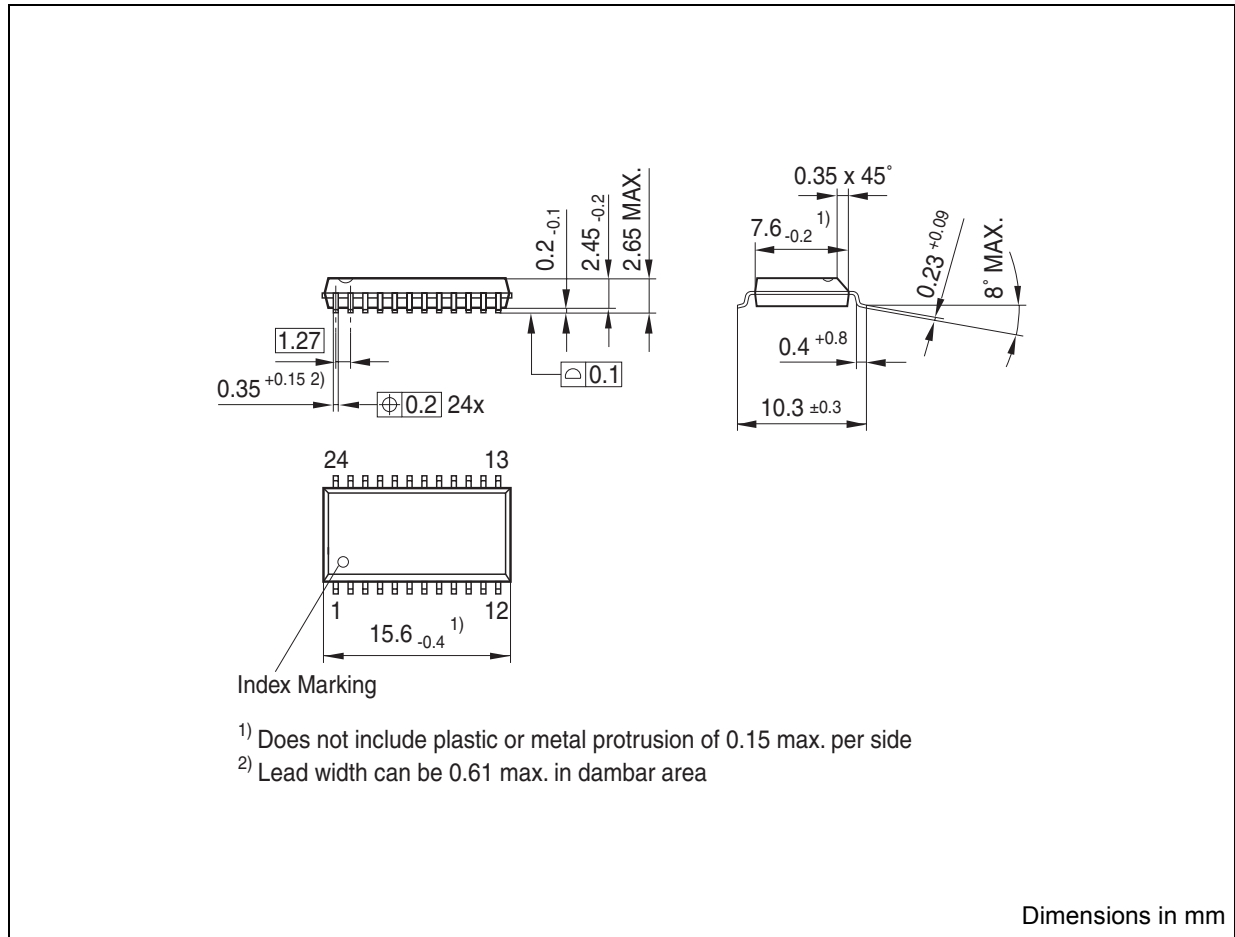
#### 4.4.6 Register Overview

Name	W/R	Addr	7	6	5	4	3	2	1	0	default 1)
IMCR	W/R	001 <sub>B</sub>	MAP7	MAP6	MAP5	MAP4	MAP3	MAP2	MAP1	MAP0	08 <sub>H</sub>
BOCR	W/R	010 <sub>B</sub>	BOL7	BOL6	BOL5	BOL4	BOL3	BOL2	BOL1	BOL0	00 <sub>H</sub>
OLCR	W/R	011 <sub>B</sub>	OVL7	OVL6	OVL5	OVL4	OVL3	OVL2	OVL1	OVL0	00 <sub>H</sub>
OTCR	W/R	100 <sub>B</sub>	OVT7	OVT6	OVT5	OVT4	OVT3	OVT2	OVT1	OVT0	00 <sub>H</sub>
SRCR	W/R	101 <sub>B</sub>	SLE7	SLE6	SLE5	SLE4	SLE3	SLE2	SLE1	SLE0	00 <sub>H</sub>
STA	R	110 <sub>B</sub>	OUT7	OUT6	OUT5	OUT4	OUT3	OUT2	OUT1	OUT0	00 <sub>H</sub>
CTL	W/R	111 <sub>B</sub>	OUT7	OUT6	OUT5	OUT4	OUT3	OUT2	OUT1	OUT0	00 <sub>H</sub>

1) The default values are set after reset.



## 5 Package Outlines SPIDER - TLE 7232G



**Figure 14** P-DSO-24-3 (Plastic Dual Small Outline Package)

You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Products": <http://www.infineon.com/products>.

## 6 Revision History

Version	Date	Changes
V1.0	05-09-30	release of data sheet

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